ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES International and Pan-Am	Bannockburn, I	Illinois. All rights reserved u	nder both Iev	nis docume vel parts, tl	ent is a declaration he declaration en	n of the substance compasses all low	es within the manufactur ver level materials for wl	er listed ite hich the ma	m. Note: if t nufacturer h	he item is an as as engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg					n		
Supplier Information												
Company name*	mpany unique ID	que ID [Unique ID Authority			Response Date*					
semi								2023-06-08				
Contact Name	t Name Title - Contact			1	Phone - Contact*				Email - Contact*			
oduct-Env-Stewards Product Enviro Compliance					NA			Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Comp			Compliance N		NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Num	nber Mfr Item Name	Mfr Item Name		Effective Date	Version	Manufacturing Site		eight*	UOM	Unit Type	
	NCV7342D10R2G HS LP CAN		RANSC (L-WU)		2023-06-08		PHG		.78	mg	Each	
Manufacturing Proccess Information					•						-	
Terminal Plating / Grid Array Materia	1 Termir	nal Base Alloy	J-STD-020 MSL Rating		Peak Proce	Peak Process Body Temperature Max Time at Pea		Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy		lloy	2		260	С	30	second	s 3			
Comments												
ATTENTION: MSL 2 Rated item requires Dry	y Pack (after o	electrical test)										
for more information regarding material com	position pleas	se refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.89	mg	Supplier	Silicon (Si)	7440-21-3		3.89	mg
Die Attach	1.25	mg		Epoxy resin	proprietary data		0.0312	mg
			Supplier	Silver (Ag)	7440-22-4		1.0563	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0312	mg
			Supplier	Inorganic filler	Proprietary Data		0.0312	mg
			Supplier	Dicyandiamine	461-58-5		0.0062	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0937	mg
Lead Frame	29.12	mg	Supplier	Zinc (Zn)	7440-66-6		0.0291	mg
			Supplier	Iron (Fe)	7439-89-6		0.6698	mg
			Supplier	Copper (Cu)	7440-50-8		28.392	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0291	mg
Mold Compound-Black	46.29	mg		Epoxy resin	proprietary data		2.3145	mg
			Supplier	Phenolic Resin	Proprietary Data		2.3145	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9258	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2315	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.5037	mg
Plating	0.96	mg	Supplier	Tin (Sn)	7440-31-5		0.96	mg
Wire Bond - Au	0.27	mg	Supplier	Gold (Au)	7440-57-5		0.27	mg